MARCH 1974 - REVISED MARCH 1988

'46A, '47A, 'LS47 feature

- **Open-Collector Outputs Drive Indicators Directly**
- Lamp-Test Provision
- Leading/Trailing Zero Suppression

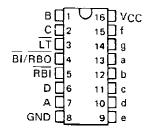
'48, 'LS48 feature

- Internal Pull-Ups Eliminate **Need for External Resistors**
- Lamp-Test Provision
- Leading/Trailing Zero Suppression

'LS49 feature

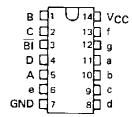
- Open-Collector Outputs
- Blanking Input

SN5446A, SN5447A, SN54LS47, SN5448, SN54LS48 . . . J PACKAGE SN7446A, SN7447A, SN7448 . . . N PACKAGE SN74LS47, SN74LS48 . . . D OR N PACKAGE (TOP VIEW)

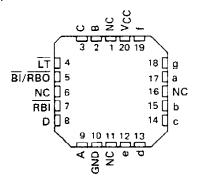


SN54LS49 . . . J OR W PACKAGE SN74LS49 . . . D OR N PACKAGE

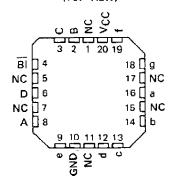
(TOP VIEW)



SN54LS47, SN54LS48 . . . FK PACKAGE (TOP VIEW)



SN54LS49 . . . FK PACKAGE (TOP VIEW)

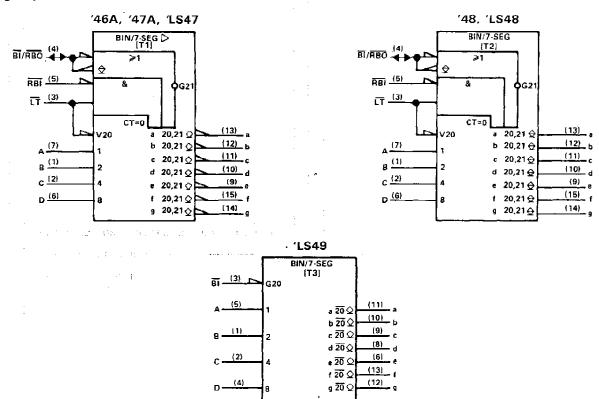


NC - No internal connection

All Circuit Types Feature Lamp Intensity Modulation Capability

	L _	DRIVER O	UTPUTS		TYPICAL	
TYPE	ACTIVE	OUTPUT	SINK	MAX	POWER	PACKAGES
	LEVEL	CONFIGURATION	CURRENT	VOLTAGE	DISSIPATION	
SN5446A	low	open-collector	40 mA	30 V	320 mW	J, W
SN5447A	low	open-collector	40 mA	15 V	320 mW	J, W
SN5448	high	2-kΩ pull-up	6.4 mA	5.5 V	265 mW	J,W
SN54LS47	low	open-collector	12 mA	15 V	35 mW	J, W
SN54L\$48	high	2-kΩ pull-up	2 mA	5.5 V	125 mW	J, W
SN54LS49	high	open-collector	4 mA	5.5 V	40 mW	J, W
SN7446A	low	open-collector	40 mA	30 V	320 mW	J, N
SN7447A	low	open-collector	40 mA	15 V	320 mW	J, N
SN7448	high	2-kΩ pull-up	6.4 mA	5.5 V	265 mW	J, N
SN74LS47	low	open-collector	24 mA	15 V	35 mW	J, N
SN74LS48	high	2-kΩ pull-up	6 mA	5.5 V	125 mW	J, N
SN74LS49	high	open-collector	8 mA	5.5 V	40 mW	J, N

logic symbols[†]



 $^{^\}dagger These$ symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

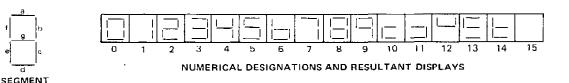


description

The '46A, '47A, and 'LS47 feature active-low outputs designed for driving common-anode LEDs or incandescent indicators directly. The '48, 'LS48, and 'LS49 feature active-high outputs for driving lamp buffers or common-cathode LEDs. All of the circuits except 'LS49 have full ripple-blanking input/output controls and a lamp test input. The 'LS49 circuit incorporates a direct blanking input. Segment identification and resultant displays are shown below. Display patterns for BCD input counts above 9 are unique symbols to authenticate input conditions.

The '46A, '47A, '48, 'LS47, and 'LS48 circuits incorporate automatic leading and/or traifing-edge zero-blanking control (RBI and RBO). Lamp test (LT) of these types may be performed at any time when the BI/RBO node is at a high level. All types (including the '49 and 'LS49) contain an overriding blanking input (BI), which can be used to control the lamp intensity by pulsing or to inhibit the outputs. Inputs and outputs are entirely compatible for use with TTL logic outputs.

The SN54246/SN74246 and '247 and the SN54LS247/SN74LS247 and 'LS248 compose the \Box and the \Box with tails and were designed to offer the designer a choice between two indicator fonts.



'46A, '47A, 'LS47 FUNCTION TABLE (T1)

		_			<u> </u>	A, LU	77 1 0110 11011								
DECIMAL OR			INP	UTS			BI/RBO↑			0	UTPUI	rs			NOTE
FUNCTION	ιŦ	RBI	D	С	В	А		а	b	С	đ	e	f	g	
0	Н	Н	L	L	L	L	H	ON	ON	ON	ON	ON	ON	OFF	
1	н	x	L	L	L	н	н	OFF	ON	ON	OFF	OFF	OFF	OFF	
2	Н	×	L	L	Н	L	Н	ON	ON	OFF	ON	ON	OFF	ON	
3	_H_	x	Ļ	L	Н	н	н	ON	ON	ON	ON_	OFF	OFF	ON	
4	н	×	L	Н	L.	L	Н	OFF	ON	ON	OFF	OFF	ON	ON	
5	H	x	L	н	L	Н	Н	ON	OFF	ON	ON	OFF	ON	ON	
6	н	x	L	н	Н	L	н	OFF	OFF	ON	ON	ON	ON	QΝ	
7	н	×	L	Н	Н	н	н	ON	ON	ON	OFF	OFF	0FF	OFF	1
8	н	х	Н	L	L	L	Н	ŌИ	ON	ON	ON	ON	ON	ON	'
9	H	x	н	L	Ł	Н	н	ON	ON	ON	OFF	OFF	ON	QΝ	
10	н	×	н	L	н	L	н	OFF	OFF	OFF	ON	ON	OFF	ON	
11	н	×	H	L	Н	н	н	OFF	OFF	ON	ON	OFF	OFF	ON	
12	Н	х	н	Н	L	L	н	OFF	ON	OFF	OFF	OFF	ON	ON	
13	н	x	н	Н	L	Н	н	ON	OFF	OFF	ON	OFF	ON	ON	
14	н	×	Н	Н	н	L	н	OFF	OFF	OFF	ON	ON	ON	ON	
15	Н	×	Н	н	н	Н	н	OFF	OFF	OFF	OFF	OFF	OFF	OFF	
BI	×	Х	Х	Х	Х	Х	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	2
RBI	н	L	L	L	L	L	L L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	3
LT	L	x	х	х	х	Х	н	ON	ON	ON	ON	ON	ON	ON	4

H = high level, L = low level, X = irrelevant

IDENTIFICATION

NOTES: 1. The blanking input (BI) must be open or held at a high logic level when output functions 0 through 15 are desired. The ripple-blanking input (RBI) must be open or high if blanking of a decimal zero is not desired.

2. When a low logic level is applied directly to the blanking input (BI), all segment outputs are off regardless of the level of any

3. When ripple-blanking input (RBI) and inputs A, B, C, and D are at a low level with the lamp test input high, all segment outputs go off and the ripple-blanking output (RBO) goes to a low level (response condition).

4. When the blanking input/ripple blanking output (81/RBO) is open or held high and a low is applied to the lamp-test input, all segment outputs are on.

†BI/BBO is wire AND logic serving as blanking input (BI) and/or ripple-blanking output (BBO).



'48, 'LS48 FUNCTION TABLE (T2)

DECIMAL OR			INPL	JTS			BI/RBO†			01	JTPU	TS			NOTE
FUNCTION	ίΤ	RBI	_ D	C	8	Α	}	а	b	c	d	e	f	g	
п	Н	н	L	L	L	L	Н	Н	Н	н	H	Н	Н	L	
1	H	х	i,	L	L	H	H	Ł	Н	H	L	L	Ł	L I	
2	Н	×	L	L	Н	L.	Н	Н	Н	L	Н	Н	Ļ	н	
3	Н	X	L,	L	H	H	н	H	<u>H</u>	Н	H	L	_L	Н	
4	Н	Х	L	Н	L	L	H	L	H	Н	L	E	Н	H	
5	H	Х	L	Н	L	Н	H	Н	L	Н	Н	L.	Н	н	
6	Н	X	Ŀ	H	H	L	Н	L	L	Н	н	Н	Н	н	
7	Н	X.	L	Н	Н	Н	Н	Н	Н	Н	L	L	L	L	,
8	Н	Х	H	L	L	Ļ	Н	Н	Н	Н	Н	Н	Н	_Н	'
9	н	x	Н	L	L	H	н	H	Н	Н	Ł	L	H	H	
10	Н	Х	Н	L	Н	L	н	L	L	L	Н	н	L	н	
11	Н	Х	H	L	Н	Н	н	L	L.	H	Н	L	_L	H	
12	Н	X	H	Н	L	L	Н	L	Н	L	L	L	Н	Н	
13	Н	х	н	Н	L	Н	Н	Н	L	L	H	L	Н	н	
14	н	х	Н	Н	Н	L	н	L	L	ŧ_	Н	Н	Н	н	
15	Н	Х	Н	_Н	Н	н	н	L.	L,	L	L	L	L.	L.	
ВІ	Х	Х	Х	Х	Х	Х	L.	L	L	L	L	L	Ĺ.	L	2
RBI	Н	L	L	L	L	L	L.) L	L	L	L	L	L	L	3
LT	L.	х	Х	Х	X	Х	н	H	Н	Н	Н	Н	Н	Н	4

H = high level, L = low level, X = irrelevant

NOTES: 1. The blanking input (BI) must be open or held at a high logic level when output functions 0 through 15 are desired. The ripple-blanking input (RBI) must be open or high, if blanking of a decimal zero is not desired.

2. When a low logic level is applied directly to the blanking input (BI), all segment outputs are low regardless of the level of any other input.

3. When ripple-blanking input (RBI) and inputs A, B, C, and D are at a low level with the lamp-test input high, all segment outputs go low and the ripple-blanking output (RBO) goes to a low level (response condition).

4. When the blanking input/ripple-blanking output (图/名图O) is open or held high and a low is applied to the lamp-test input, all segment outputs are high.

†BI/RBO is wire-AND logic serving as blanking input (BI) and/or ripple blanking output (RBO).

'LS49 FUNCTION TABLE (T3)

DECIMAL OR		11	VPUT	S				OU	JTPU	TS			NOTE
FUNCTION	D	С	8	Α	BI	a	ь	c	ď	е	_ f	g	
0	L	Ĺ	L.	L	Н	Н	Н	Н	Н	Н	Н	L	
1	Ł	L	L	Н	Н	L	Н	Н	L	L	L	Ļ	
2	L,	L	Н	L	Н] н	Н	L	Н	Н	L	Н	
3	L	L	_H_	_H	Н	н	Η.	H	Н	_L	L	_ H	
4	L	Н	L	L	Н	L	Н	Н	L	L	Н	H	
5	L	Н	L	н	Н	Н	L	Н	H	L	Н	Н	
6	L	Н	Н	L	Н	L	L	H	Н	Н	Н	Η]
7	L	Н	Н	Н	_H	Н	. H_	_ H_	_L	L	L	L_] ,]
8	Н	L	L	L	Н	Н	H	Н	Н	Н	H	Н	'
9	Н	L	L	Н	н	Н	H	Н	L.	L	Н	Н	
10	Н	L	Н	L	н	L	L	L	Н	Н	L	H	
11	Н	L	Н	Н	Н	L	L	H	Н	L	L	Н	
12	Н	Н	L	L	Н	L	Н	L	L	L	Н	Н	
13	Н	Н	L	Н	Н	Н	L	L	H	L	Н	H	
14	[н	H	Н	L	Н	L	L	L	Н	Н	H	H	
15	Н	H	Н	Н	н	L	L	L	L	L	L	_ L	
BI	X	Х	Х	X	L	L	L	Ļ	L	L	L	L	2

H - high level, L = low level, X = irrelevent

NOTES: 1. The blanking input (BI) must be open or held at a high logic level when output functions 0 through 15 are desired.

2. When a low logic level is applied directly to the blanking input (BI), all segment outputs are low regardless of the level of any other input.

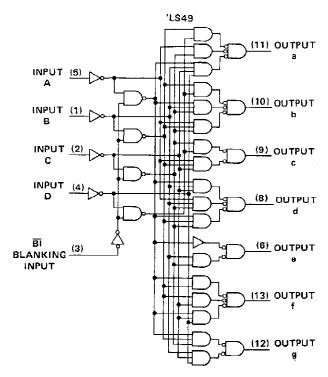


logic diagrams (positive logic) '46A, '47A, 'LS47 (13) OUTPUT INPUT (7) А INPUT (1) (12) OUTPUT В INPUT (2) (11) OUTPUT C INPUT (6) (10) OUTPUT D BI/RBO **BLANKING** (9) OUTPUT INPUT OR RIPPLE-BLANKING OUTPUT (15) OUTPUT LT LAMP-TEST (3) INPUT (14) OUTPUT RBI RIPPLE-BLANKING (5) '48, 'L\$48 (13) OUTPUT INPUT (7) А (12) OUTPUT INPUT (1) В INPUT (2) (11) OUTPUT C INPUT (6) (10) OUTPUT D d BI/RBO BLANKING (9) OUTPUT (4) INPUT OR е RIPPLE-BLANKING OUTPUT (15) OUTPUT ĹŤ LAMP-TEST (3) INPUT RBI (14) OUTPUT RIPPLE-BLANKING (5) g INPUT

Pin numbers shown are for D, J, N, and W packages.



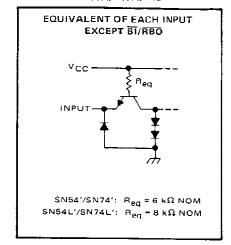
logic diagrams (continued)



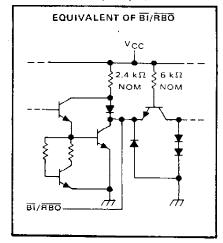
Pin numbers shown are for D, J, N, and W packages.

schematics of inputs and outputs

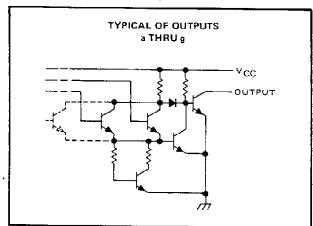
'46A, '47A, '48



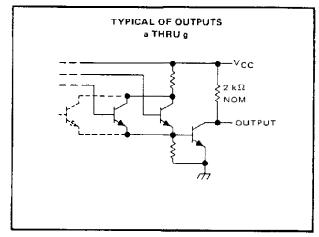
'46A, '47A, '48



'46A, '47A



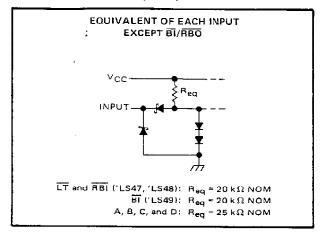
'48



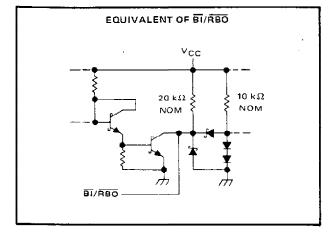
SN54LS47, 'LS48, 'LS49, SN74LS47, 'LS48, 'LS49 BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS

schematics of inputs and outputs

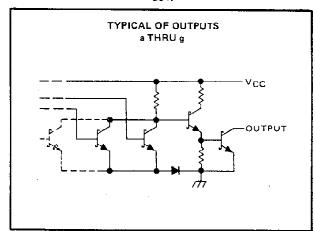
'LS47, 'LS48, 'LS49



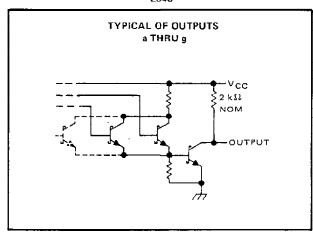
'LS47, 'LS48, 'LS49



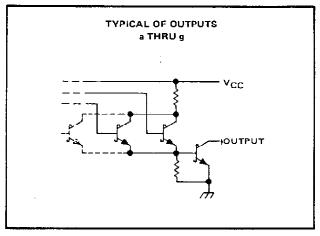
'LS47



'LS48



'LS49



SN5446A, SN5447A, SN7446A, SN7447A BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1) , ,	7 V
Input voltage , , , , ,	δV
Current forced into any output in the off state	
Operating free-air temperature range: SN5446A, SN5447A	
SN7446A, SN7447A)°C
Storage temperature range	ງ°ຕ

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN5446	A	5	N5447	A	5	N7446	Δ	9	N7447	Α	UNIT
		MtN	NOM	MAX	MIN	NOM	MAX	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.5	5	5.5	4.5	5	5.5	4.75	5	5.25	4.75	5	5.25	V
Off-state output voltage, VO(off)	a thru g			30			15			30			15	V
On-state output current, IO(on)	a thru g			40			40		-	40			40	mA
High-level output current, IOH	81/R80	Ì		-200			-200			-200			-200	μА
Low-level output current, IOL	BI/RBO			8			8	-		8			8	mA
Operating free-air temperature, To	\	-55		125	-55		125	0		70	0		70	°C_

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CON	IDITIONS [†]	MIN	TYP‡	MAX	UNIT
ViH	High-level input voltage				2	•		V
٧١L	Low-level input voltage			***			8.0	V
VIK	Input clamp voltage		VCC = MIN.	lj = -12 mA			-1.5	V
V _{OH}	High-level output voltage	BI/RBÖ	V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OH} = -200 μA	2.4	3.7		٧
VOL	Low-level output voltage	BI/RBO	V _{CC} = MIN, V _{IL} = 0.8 V,			0.27	0.4	٧
lO(off)	Off-state output current	a thru g	V _{CC} = MAX, V _{IL} = 0.8 V,	V _{IH} = 2 V, V _{O(off)} = MAX		-	250	μА
VO(on)	On-state output voltage	a thru g	V _{CC} = MIN, V _{IL} = 0.8 V,	$V_{IH} = 2 V$, $I_{O(on)} = 40 \text{ mA}$		0.3	0,4	V
l _l	Input current at maximum input voltage	Any input except BI/RBO	V _{CC} = MAX,	V ₁ = 5.5 V			1	mA
ΉΗ	High-level input current	Any input except BI/RBO	V _{CC} = MAX,	V _I = 2.4 V			40	μА
4L	Low-level input current	Any input except 81/RBO	V _{CC} = MAX,	V ₁ = 0.4 V			-1.6	mA
		BI/RBO			<u> </u>		-4	
los	Short-circuit output current	BI/RBO	V _{CC} = MAX				_4	mΑ
Icc	Supply current		V _{CC} = MAX, See Note 2	SN54' SN74'		64 64	85 103	mΑ

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25°C

	PARAMETER	TEST CONDITIONS	MIN	TYP MAX	UNIT
toff	Turn-off time from A input			100	ns
tan	Turn-on time from A input	$C_{L} = 15 pF$, $R_{L} = 120 \Omega$,		100] ""
toff	Turn-off time from RBI input	See Note 3		100	ns
ton	Turn-on time from RBI input			100	



 $[\]ddagger$ All typical values are at V_{CC} = 5 V, T_A = 25°C. NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)																7 V
Input voltage ,															5.!	5 V
Operating free-air temperature range	: \$N5448											_E	;5°ເ	C to	125	5°C
	SN7448															
Storage temperature range																

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN5448	В		SN744	8	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	0.411
Supply voltage, VCC	·	4.5	5	5.5	4.75	5	5.25	ν
High level entered entered in	a thru g			-400			-400	
High-level output current, IOH	BI/ABO			-200			-200	μА
Low lovel motors are account to	a thru g			6.4			6.4	
Low-level output current, IOL	BI/RBO			8			- 8	mΑ
Operating free-air temperature, TA		-55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CON	DITIONST	MIN	TYP1	MAX	UNIT
VIH	High-level input voltage				2			V
VIL	Low-level input voltage						8.0	V
VtK	Input clamp voltage		V _{CC} - MIN, I	= −12 mA			1.5	٧
Voн	High-level output voltage	a thru g	V _{CC} = MIN, V	/ _{IH} = 2 V,	2.4	4.2		V
TOH	riigii-iovoi odipai voitage	BI/RBO	V _{1L} = 0.8 V, I	XAM = HC	2.4	3.7		· · ·
10	Output current	a thru g	VCC = MIN, V	~	-1.3	-2		mA
VOL	Low-level output voltage		V _{CC} = MIN, V V _{IL} = 0.8 V, I			0.27	0.4	V
lį.	Input current at maximum input voltage	Any input except BI/RBO	V _{CC} = MAX, V	/ = 5.5 V			1	mA
ΊΗ	High-level input current	Any input except BI/RBO	V _{CC} - MAX, V	/ ₁ = 2.4 V			40	μΑ
!	Low-level input current		VCC = MAX, V	/ _I = 0.4 V			-1.6	mA
los	Short-circuit output current	BI/RBO BI/RBO	V _{CC} = MAX		+		<u>-4</u> -4	mΔ
Icc	Supply current	•	V _{CC} = MAX, See Note 2	SN5448 SN7448		53 53	76 90	mΑ

For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25 ^{\circ}\text{C}$

PARAMETER	TEST CONDITIONS	MIN TYP	MAX	UNIT
tPHL Propagation delay time, high-to-low-level output from A input			100	
tpLH Propagation delay time, low-to-high-level output from A input	C _L = 15 pF, R _L = 1 kΩ		100	ns
tpht Propagation delay time, high-to-low-level output from RBI input	See Note 3		100	ns
[†] PLH Propagation delay time, low-to-high-level output from RBI input			100	113



 $[\]ddagger$ All typical values are at V_{CC} = 5 V, T_A = 25°C. NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V.

SN54LS47, SN74LS47 BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted) Supply voltage, VCC (see Note 1) Input voltage Current forced into any output in the off state Operating free-air temperature range: SN54LS47 SN74LS47 SN74LS47 SN6 C to 70°C SN74LS47

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		S	N54LS4	17	S	N74LS4	17	LINIT
		MIN	NOM	MAX	MIN	NOM	MAX	TINU
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	٧
Off-state output voltage, VO(off)	a thru g			15			15	V
On-state output current, IO(on)	a thiu g			12			24	mΑ
High-level output current, IOH	BI/RBO			-50			-50	μА
Low-level output current, IOL	BÎ/ABQ			1.6	1		3.2	mA
Operating free-air temperature, TA		-55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST OOM	DITIONET	S	N54LS4	17	S	N74LS	47	
	FANAMETER		TEST CON	IDITIONS.	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage				2			2			V
VIL	Low-level input voltage						0.7			8.0	V
VIK	Input clamp voltage		V _{CC} = MIN,	I ₁ =18 mA			-1.5			-1.5	V
v _{он}	High-level output voltage	ิย์I∕R8 Q	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, 1 _{OH} = -50 μA	2.4	4.2		2.4	4.2		V
VOL	Low-level output voltage	BI/REO	V _{CC} = MIN, V _{IH} = 2 V,	I _{OL} = 1.6 mA		0.25	0.4		0.25	0.4	V
-00			V _{IL} = V _{IL} max	t _{OL} = 3.2 mA					0.35	0.5	L ,
¹ O(off)	Off-state output current	a thru g	VCC = MAX, V _{IL} = V _{IL} max,	V _{IH} = 2 V, V _{O(off)} = 15 V			250			250	μΑ
VO(an)	On-state output voltage	a thru g	V _{CC} = MIN, V _{IH} = 2 V,	IO(on) = 12 mA		0.25	0.4		0.25	0.4	V
O(dii)		<u>.</u>	V _{IL} = V _{IL} max	IO(оп) = 24 mA					0.35	0.5	
ŧ _l	Input current at maximur	n input voltage	V _{CC} = MAX,	V _I = 7 V			0.1			0.1	mA
Iн	High-level input current		V _{CC} = MAX,	V ₁ = 2.7 V			20			20	μА
l _I L	Low-level input current	Any input except BI/RBO	V _{CC} = MAX,	V _I = 0.4 V			-0.4			-0.4	mA
		BĨ/RBO					-1.2			-1.2	
los	Short-circuit output current	BI/RBO	V _{CC} = MAX		-0.3		-2	-0.3		-2	mΑ
1cc	Supply current	-	V _{CC} = MAX,	See Note 2		7	13		7	13	mA

 $^{^\}dagger$ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 ‡ All typical values are at V_{CC} = 5 V, T_A = 25°C. NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V.

switching characteristics, VCC = 5 V, TA = 25 °C

Į.	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
toff	Turn-off time from A input				100	ne
ton	Turn-on time from A input	$C_L = 15 pF, R_L = 665 \Omega,$			100	ns
†off	Turn-off time from RBi input, outputs (a-f) only	See Note 3			100	ns
ton	Turn-on time from RBI input, outputs (a-f) only				100	5



SN54LS48, SN74LS48 BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS

absolute maximum ratings over opera	ıting free-ai	r te	m	per	atı	ure	rar	nge) (L	ınl	ess	0	the	erv.	/is	e r	101	tec	(t					
Supply voltage, VCC (see Note 1) .																				-			7	7 V
Input voltage																								
Operating free-air temperature range:	SN54LS48																	,		-£	;5°(C to	125	°C
	SN74LS48		-				-								-	÷		-			0	°C t	o 70	າູ C
Storage temperature range											-									-6	ວ້ວິເ	C to	150)°C
NOTE 1: Voltage values are with respect to netwo	ork ground ter	min	al,																					

recommended operating conditions

		s	N54LS4	18	S	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V
III ab ta at a second at the second at	a thru g			-100			-100	
High-level output current, IOH	BI/RBO			-50			-50	μА
	a thru g			2			6	
Low-level output current, IQL	BI/RBO		-	1.6			3.2	mA
Operating free-air temperature, TA		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DADAMETED	_	TECT OOL		S	N54LS4	8	S	N74LS4	18	
	PARAMETER		1551 CON	IDITIONS [†]	MIN	TYP‡	MAX	MIN	TYP [‡]	MAX	UNIT
VIH	High-level input voltage	-			2			2			V
VIL	Low-level input voltage						0.7			0.8	V
VΙĶ	Input clamp voltage		V _{CC} = MIN,	I _I = -18 mA			-1.5			-1.5	٧
vон	High-level output voltage	a thrug and BI/RBO	V _{CC} = MIN, V _{IL} = V _{IL} max,		2.4	4.2		2.4	4.2		V
IO	Output current	a thru g	V _{CC} = MIN, Input conditions	-	-1.3	-2		-1.3	-2		mA
		a thru q	V _{CC} = MIN, V _{IH} = 2 V,	1 _{OL} = 2 mA		0.25	0.4		0.25	0.4	,
Vol	Low-level output voltage	a ting	V _{IL} = V _{IL} max	IOL = 6 mA					0.35	0.5	•
FUL	con level output voltage	BI/RBO	V _{CC} = MIN, V _{IH} = 2 V.	IOL = 1.6 mA		0.25	0.4		0.25	0.4	V
_		BISTINO	VIH = VIL max	I _{OL} = 3.2 mA					0.35	0.5	
ц	Input current at maximum input voltage	Any input except BI/BRO	V _{CC} = MAX,	V ₁ = 7 V			0.1			0.1	mA
Ιн	High-level input current	Any input except BI/RBO	V _{CC} = MAX,	V ₁ = 2.7 V			20			20	μА
l _{IL}	Low-level input current	Any input except BI/RBO	V _{CC} = MAX,	V _I = 0.4 V			-0.4			-0.4	mА
		BI/RBO	<u> </u>				-1.2			-1.2	<u> </u>
los	Short-circuit output current	BI/ÑBÓ	V _{CC} = MAX		-0.3		2	-0.3	·	-2	mA
lcc	Supply current		VCC = MAX,	See Note 2		25	38		25	38	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡All typical values are at V_{CC} = 5 V, T_A 25°C.

NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25 ^{\circ}\text{C}$

PARAMETER PARAMETER	TEST CONDITIONS	MIN TYP	MAX	UNIT
tPHL Propagation delay time, high-to-low-level output from A input	$C_L = 15 \text{ pF}, H_L = 4 \text{ k}\Omega,$		100	'
tpLH Propagation delay time, low-to-high-level output from A input	See Note 3		100	ns
tpHL Propagation delay time, high-to-low-level output (a-f only) from RBI input	$C_L = 15 pF$, $R_L = 6 k\Omega$,		100	лѕ
[†] PLH Propagation delay time, low-to-high-level output (a-f only) from RBI input	See Note 3		100	113



SN54LS49, SN74LS49 BCD-TO-SEVEN-SEGMENT-DECODERS/DRIVERS

absolute maximum ratings over operati	ng free-a	ir t	em	pe	ra	tur	e r	ang	ge	(u	nle	:ss	ot	he	r٧	/is	e r	10	tec	d)					
Supply voltage, VCC (see Note 1)																									7 V
Input voltage															_										7 V
Current forced into any output in the o	off state																								1 mA
Operating free-air temperature range: S	SN54LS49			-						-								-			-5	55°	C t	to '	125°C
S	N74LS49																					C)°C	; to	∙70°C
Storage temperature range				-								-		-							$-\epsilon$	35°	C	to '	150°C
NOTE 1: Voltage values are with respect to network	k ground te	rmir	nal.																						

recommended operating conditions

	S	N54LS4	19	S			
	MIN	MOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	\vdash_{\vee}
High-level output voltage, VOH		-	5.5			6.5	V
Low-level output current, IOL			4			8	mA
Operating free-air temperature, TA	-55		125	0	_	70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	7507.004	VDITIONS [†]	S	N54LS4	19	S	N74LS4	9	
	TANAMICTER		ADITIONS:	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
ViH	High-level input voltage			2			2			V
VIL	Low-level input valtage					0.7			0.8	V
VIK	Input clamp voitage	V _{CC} = MIN,	I _I = -18 mA	<u> </u>		-1.5	-		-1.5	V
юн	High-level output current	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, V _{OH} = 5.5 V	_		250			250	μΑ
VOL	Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V,	1 _{OL} = 4 mA		0.25	0.4		0.25	0.4	\ \ \
		VIL = VIL max	IOL = 8 mA					0.35	0.5] `
[4]	Input current at maximum input voltage	VCC = MAX,	V ₁ = 7 V	1 -		0.1			0.1	mA
ЧН	High-level input current	V _{CC} = MAX,	V ₁ = 2.7 V	1 -		20			20	μА
TIL	Low-level input current	V _{CC} = MAX,	V ₁ = 0.4 V	 		-0.4			-0.4	mA
lcc	Supply current	VCC = MAX,	See Note 2	 	8	15	-	- 8	15	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25 \, ^{\circ}\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPHL Propagation delay time, high-to-low-level output from A input	$C_L = 15 pF$, $R_L = 4 k\Omega$,			100	
tplH Propagation delay time, low-to-high-level output from A input	See Note 3			100	ns
tpнլ Propagation delay time, high-to-low-level output (a-f only) from RBI input	$C_L = 15 \text{ pF}, R_L = 6 \text{ k}\Omega,$			100	
^t PLH Propagation delay time, low-to-high-level output (a-f only) from RBI input	See Note 3			100	ns

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V.

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